# **Digital FET, Dual N-Channel**

## FDG6301N

#### **General Description**

These dual N–Channel logic level enhancement mode field effect transistors are produced using ON Semiconductor's proprietary, high cell density, DMOS technology. This very high density process is especially tailored to minimize on–state resistance. This device has been designed especially for low voltage applications as a replacement for bipolar digital transistors and small signal MOSFETs.

### Features

- 25 V, 0.22 A Continuous, 0.65 A Peak
  - $R_{DS(ON)} = 4 \Omega @ V_{GS} = 4.5 V$
  - $R_{DS(ON)} = 5 \Omega @ V_{GS} = 2.7 V$
- Very Low Level Gate Drive Requirements Allowing Direct Operation in 3 V Circuits (V<sub>GS(th)</sub> < 1.5 V)
- Gate-Source Zener for ESD Ruggedness (>6 kV Human Body Model)
- Compact Industry Standard SC70-6 Surface Mount Package
- These Devices are Pb-Free and are RoHS Compliant

Symbol	Parameter		FDG6301N	Units
V <sub>DSS</sub>	Drain-Source Voltage		25	V
V <sub>GSS</sub>	Gate-Source Voltage		8	V
Ι <sub>D</sub>	Drain/Output Current	Continuous	0.22	А
		Pulsed	0.65	
PD	Maximum Power Dissipat	0.3	W	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range		–55 to +150	°C
ESD	Electrostatic Discharge R MIL-STD-883D Human Body Model (100	0	6.0	kV

#### **ABSOLUTE MAXIMUM RATINGS** (T<sub>A</sub> = 25°C unless otherwise noted)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.



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SC-88/SC70-6/SOT-363 CASE 419B-02





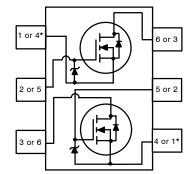
= Specific Device Code

01

М

= Assembly Operation Month

#### PIN CONNECTIONS



\*The pinouts are symmetrical; pin 1 and 4 are interchangeable.

Units inside the carrier can be of either orientation and will not affect the functionality of the device.

### ORDERING INFORMATION

See detailed ordering and shipping information on page 5 of this data sheet.

#### THERMAL CHARACTERISTICS

	Symbol	Parameter	Ratings	Unit
ĺ	$R_{\thetaJA}$	Thermal Resistance, Junction-to-Ambient (Note 1)	415	°C/W

 R<sub>θJA</sub> is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R<sub>θJC</sub> is guaranteed by design while R<sub>θCA</sub> is determined by the user's board design. R<sub>θJA</sub> = 415°C/W on minimum pad mounting on FR-4 board in still air.

#### ELECTRICAL CHARACTERISTICS (T<sub>A</sub> = 25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Тур	Max	Unit	
OFF CHARACTERISTICS							
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$V_{GS}$ = 0 V, I <sub>D</sub> = 250 $\mu$ A	25	-	-	V	
$\Delta \text{BV}_{\text{DSS}}  /  \Delta \text{T}_{\text{J}}$	Breakdown Voltage Temperature Coefficient	$I_D$ = 250 µA, Referenced to 25°C	-	25	-	mV/°C	
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS}$ = 20 V, $V_{GS}$ = 0 V	-	-	1	μΑ	
		$V_{DS}$ = 20 V, $V_{GS}$ = 0 V, $T_J$ = 55 $^\circ C$	-	-	10	μΑ	
I <sub>GSS</sub>	Gate-Body Leakage Current	$V_{GS} = 8 V, V_{DS} = 0 V$	-	-	100	nA	
ON CHARACTE	ON CHARACTERISTICS (Note 2)						

0.65 V Gate Threshold Voltage  $V_{DS}=V_{GS},\,I_{D}=250\;\mu A$ 0.85 1.5 V<sub>GS(th)</sub>  $\Delta V_{GS(th)} / \Delta T_J$ Gate Threshold Voltage  $I_D = 250 \ \mu$ A, Referenced to  $25^{\circ}$ C -2.1 mV/°C \_ \_ Temperature Coefficient Static Drain-Source  $V_{GS}$  = 4.5 V,  $I_D$  = 0.22 A R<sub>DS(on)</sub> \_ 2.6 4 Ω **On-Resistance**  $V_{GS}$  = 4.5 V,  $I_D$  = 0.22 A,  $T_J$  = 125°C 5.3 7 \_  $V_{GS} = 2.7 \text{ V}, I_D = 0.19 \text{ A}$ 3.7 5 \_ **On-State Drain Current**  $V_{GS} = 4.5 V, V_{DS} = 5 V$ 0.22 А I<sub>D(on)</sub> \_ - $V_{DS} = 5 \text{ V}, I_{D} = 0.22 \text{ A}$ S Forward Transconductance 0.2 **g**fs \_

#### DYNAMIC CHARACTERISTICS

C <sub>iss</sub>	Input Capacitance	$V_{DS}$ = 10 V, $V_{GS}$ = 0 V, f = 1.0 MHz	_	9.5	-	pF
C <sub>oss</sub>	Output Capacitance		-	6	-	pF
C <sub>rss</sub>	Reverse Transfer Capacitance		-	4.5	-	pF

#### SWITCHING CHARACTERISTICS (Note 2)

t <sub>D(on)</sub>	Turn-On Delay Time	$V_{DD} = 5 V, I_D = 0.5 A,$	-	5	10	ns
t <sub>r</sub>	Turn-On Rise Time	$V_{\rm GS}$ = 4.5 V, $R_{\rm GEN}$ = 50 $\Omega$	-	4.5	10	ns
t <sub>D(off)</sub>	Turn-Off Delay Time		-	4	8	ns
t <sub>f</sub>	Turn-Off Fall Time		-	3.2	7	ns
Qg	Total Gate Charge	$V_{DS} = 5 V, I_D = 0.22 A,$ $V_{GS} = 4.5 V$	-	0.29	0.4	nC
Q <sub>gs</sub>	Gate-Source Charge	$v_{GS} = 4.5 v$	-	0.12	-	nC
Q <sub>gd</sub>	Gate-Drain Charge		-	0.03	-	nC

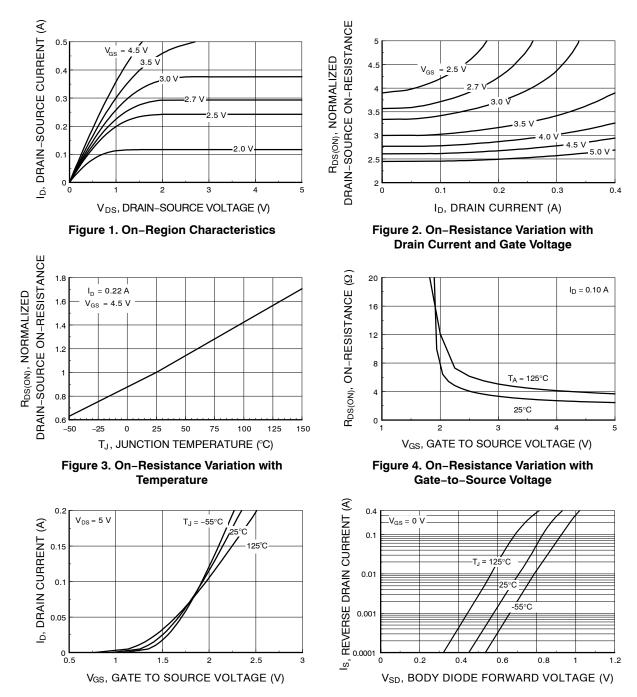
#### DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS

I <sub>S</sub>	Maximum Continuous Source Current		-	-	0.25	А
V <sub>SD</sub>	Drain-Source Diode Forward Voltage	$V_{GS}$ = 0 V, $I_S$ = 0.25 A (Note 2)	-	0.8	1.2	V

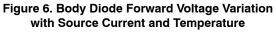
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

2. Pulse Test: Pulse Width  $\leq$  300  $\mu$ s, Duty Cycle  $\leq$  2.0%

### **TYPICAL PERFORMANCE CHARACTERISTICS**







### TYPICAL PERFORMANCE CHARACTERISTICS (continued)

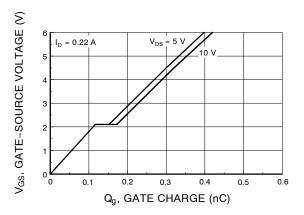


Figure 7. Gate Charge Characteristics

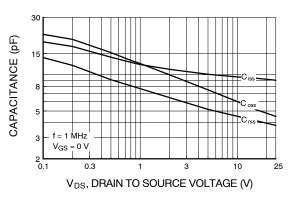


Figure 8. Capacitance Characteristics

SINGLE PULSE

 $R_{\theta JA} = 415^{\circ}C/W$ 

10

200

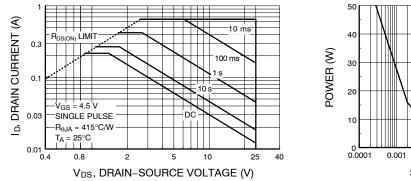
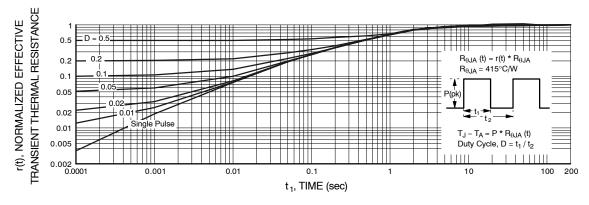


Figure 9. Maximum Safe Operating Area

SINGLE PULSE TIME (sec) Figure 10. Single Pulse Maximum Power Dissipation

0.1

0.01



Thermal characterization performed using the conditions described in Note 1. Transient thermal response will change depending on the circuit board design.

Figure 11. Transient Thermal Response Curve

#### **ORDERING INFORMATION**

Device Order Number	Device Marking	Package Type	Shipping <sup>†</sup>
FDG6301N	01	SC-88/SC70-6/SOT-363 (Pb-Free)	3000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

0.043

0.004





- XXX = Specific Device Code

(Note: Microdot may be in either location)

\*Date Code orientation and/or position may vary depending upon manufacturing location.

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.



DIMENSIONS: MILLIMETERS

\*For additional information on our Pb-Free strategy and soldering

details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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#### SC-88/SC70-6/SOT-363 CASE 419B-02 ISSUE Y

#### DATE 11 DEC 2012

STYLE 1: PIN 1. EMITTER 2 2. BASE 2 3. COLLECTOR 1 4. EMITTER 1 5. BASE 1 6. COLLECTOR 2	STYLE 2: CANCELLED	STYLE 3: CANCELLED	STYLE 4: PIN 1. CATHODE 2. CATHODE 3. COLLECTOR 4. EMITTER 5. BASE 6. ANODE	STYLE 5: PIN 1. ANODE 2. ANODE 3. COLLECTOR 4. EMITTER 5. BASE 6. CATHODE	STYLE 6: PIN 1. ANODE 2 2. N/C 3. CATHODE 1 4. ANODE 1 5. N/C 6. CATHODE 2
STYLE 7: PIN 1. SOURCE 2 2. DRAIN 2 3. GATE 1 4. SOURCE 1 5. DRAIN 1 6. GATE 2	STYLE 8: CANCELLED	STYLE 9: PIN 1. EMITTER 2 2. EMITTER 1 3. COLLECTOR 1 4. BASE 1 5. BASE 2 6. COLLECTOR 2	STYLE 10: PIN 1. SOURCE 2 2. SOURCE 1 3. GATE 1 4. DRAIN 1 5. DRAIN 2 6. GATE 2	STYLE 11: PIN 1. CATHODE 2 2. CATHODE 2 3. ANODE 1 4. CATHODE 1 5. CATHODE 1 6. ANODE 2	STYLE 12: PIN 1. ANODE 2 2. ANODE 2 3. CATHODE 1 4. ANODE 1 5. ANODE 1 6. CATHODE 2
STYLE 13:	STYLE 14:	STYLE 15:	STYLE 16:	STYLE 17:	STYLE 18:
PIN 1. ANODE	PIN 1. VREF	PIN 1. ANODE 1	PIN 1. BASE 1	PIN 1. BASE 1	PIN 1. VIN1
2. N/C	2. GND	2. ANODE 2	2. EMITTER 2	2. EMITTER 1	2. VCC
3. COLLECTOR	3. GND	3. ANODE 3	3. COLLECTOR 2	3. COLLECTOR 2	3. VOUT2
4. EMITTER	4. IOUT	4. CATHODE 3	4. BASE 2	4. BASE 2	4. VIN2
5. BASE	5. VEN	5. CATHODE 2	5. EMITTER 1	5. EMITTER 2	5. GND
6. CATHODE	6. VCC	6. CATHODE 1	6. COLLECTOR 1	6. COLLECTOR 1	6. VOUT1
STYLE 19:	STYLE 20:	STYLE 21:	STYLE 22:	STYLE 23:	STYLE 24:
PIN 1. I OUT	PIN 1. COLLECTOR	PIN 1. ANODE 1	PIN 1. D1 (i)	PIN 1. Vn	PIN 1. CATHODE
2. GND	2. COLLECTOR	2. N/C	2. GND	2. CH1	2. ANODE
3. GND	3. BASE	3. ANODE 2	3. D2 (i)	3. Vp	3. CATHODE
4. V CC	4. EMITTER	4. CATHODE 2	4. D2 (c)	4. N/C	4. CATHODE
5. V EN	5. COLLECTOR	5. N/C	5. VBUS	5. CH2	5. CATHODE
6. V REF	6. COLLECTOR	6. CATHODE 1	6. D1 (c)	6. N/C	6. CATHODE
STYLE 25:	STYLE 26:	STYLE 27:	STYLE 28:	STYLE 29:	STYLE 30:
PIN 1. BASE 1	PIN 1. SOURCE 1	PIN 1. BASE 2	PIN 1. DRAIN	PIN 1. ANODE	PIN 1. SOURCE 1
2. CATHODE	2. GATE 1	2. BASE 1	2. DRAIN	2. ANODE	2. DRAIN 2
3. COLLECTOR 2	3. DRAIN 2	3. COLLECTOR 1	3. GATE	3. COLLECTOR	3. DRAIN 2
4. BASE 2	4. SOURCE 2	4. EMITTER 1	4. SOURCE	4. EMITTER	4. SOURCE 2
5. EMITTER	5. GATE 2	5. EMITTER 2	5. DRAIN	5. BASE/ANODE	5. GATE 1
6. COLLECTOR 1	6. DRAIN 1	6. COLLECTOR 2	6. DRAIN	6. CATHODE	6. DRAIN 1

Note: Please refer to datasheet for style callout. If style type is not called out in the datasheet refer to the device datasheet pinout or pin assignment.

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